DAB2190 SSI2190 SSOP-TO-DIP ADAPTER BOARD Support Products

While the SSI2190's compact SSOP package allows dense PCB layouts, the condensed lead pitch can be a challenge during prototyping and evaluation. The DAB2190 solves the problem by providing a SSI2190 and two power supply decoupling caps on a PCB with very manageable 0.10" spaced through-hole header leads.

Refer to the SSI2190 data sheet for detailed information on application of the DAB2190.

SPECIFICATIONS

- Lead pitch: 2.54mm (0.10")
- Row spacing: 15.24mm (0.60")
- Lead diameter: 0.64mm (0.025")
- PCB hole diameter: 1.02mm (0.04")
- Approximate PCB size: 30mm x 17mm
- Cap value: 0.1µF, 50V X7R



